

Features

- RoHS compliant*
- SMC package
- Surface mount
- High current capability



CD214C-B320 ~ B360 Schottky Barrier Rectifier Chip Diode

General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

Bourns offers Schottky Rectifier Diodes for rectification applications, in compact chip package DO-214AB (SMC) size format, which offer PCB real estate savings and are considerably smaller than competitive parts. The Schottky Rectifier Diodes offer a forward current of 3 A with a choice of repetitive peak reverse voltage of 20 V up to 60 V.

Bourns® Chip Diodes conform to JEDEC standards, are easy to handle with standard pick and place equipment and their flat configuration minimizes roll away.

Electrical Characteristics (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CD214C-					Unit
		B320	B330	B340	B350	B360	
Forward Voltage (Max.) (I _f = 3 A)	V _F	0.5	0.5	0.5	0.7	0.7	V
Typical Junction Capacitance*	C _T			250			pF
Reverse Current (Max.) at Rated V_R)	I _R			0.5			mA

Measured at 1.0 MHz and applied reverse voltage of 4.0 V DC.

Absolute Ratings (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CD214C-					Unit
		B320	B330	B340	B350	B360]
Repetitive Peak Reverse Voltage	V _{RRM}	20	30	40	50	60	V
Reverse Voltage	V _R	20	30	40	50	60	V
Maximum RMS Voltage	V _{RMS}	14	21	28	35	42	V
Avg. Forward Current	Io	3			Α		
Forward Current, Surge Peak (60 Hz, 1 cycle)	I _{surge}	100			А		
Typical Thermal Resistance**	$R_{\Theta JL}$	10			°C/W		
Storage Temperature	T _{STG}	-55 to +150			°C		
Junction Temperature	TJ	-55 to +125			°C		

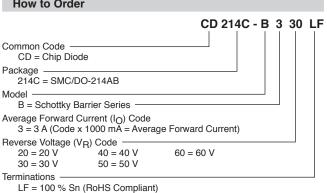
^{**} Thermal resistance iunction to lead.

*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

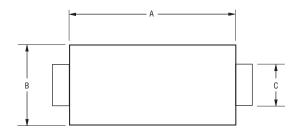
How to Order

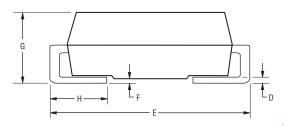


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Product Dimensions

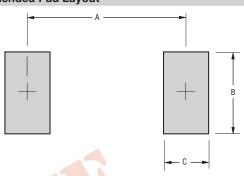




Dimension	SMC (DO-214AB)		
А	<u>6.60 - 7.11</u> (0.260 - 0.280)		
В	5.59 - 6.22 (0.220 - 0.245)		
С	2.92 - 3.18 (0.115 - 0.125)		
D	0.15 - 0.31 ().006 - 0.112)		
E	<u>7.75 - 8.13</u> (0.305 - 0.320)		
F	<u>0.05 - 0.20</u> (0.002 - 0.008)		
G	<u>2.01 - 2.62</u> (0.080 - 0.103)		
Н	<u>0.76 - 1.52</u> (0.030 - 0.060)		

DIMENSIONS: $\frac{MM}{(INCHES)}$

Recommended Pad Layout



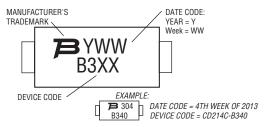
Dimension	SMC (DO-214AB)		
A	7.90 (0.311)		
В	<u>4.00</u> (0.157)		
С	2.30 (0.091)		

DIMENSIONS: $\frac{MM}{(INCHES)}$

Physical Specifications

Case	Molded plastic
Polarity	Indicated by cathode band
Weight	0.007 ounces / 0.21 grams

Typical Part Marking

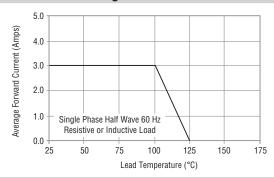


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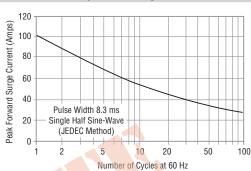
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Rating and Characteristic Curves

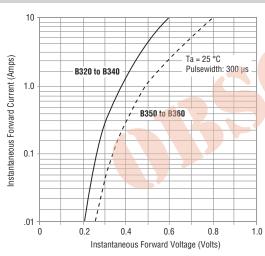
Forward Current Derating Curve



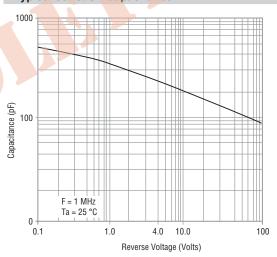
Maximum Non-Repetitive Surge Current



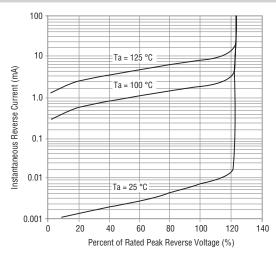
Typical Forward Characteristics



Typical Junction Capacitance



Typical Reverse Characteristics

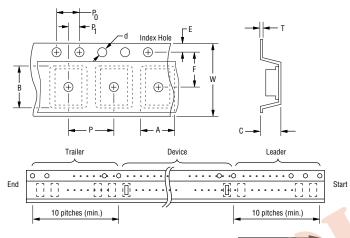


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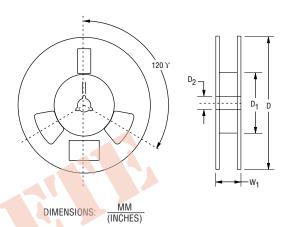
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Packaging Information

The product will be dispensed in Tape and Reel format (see diagram below).







Devices are packed in accordance with EIA standard RS-481-A and specifications shown here.

Item	Symbol	SMC (DO-214AB)
Carrier Width	A	$\frac{7.22 \pm 0.10}{(0.284 - 0.004)}$
Carrier Length	В	$\frac{8.11 \pm 0.10}{(0.319 - 0.004)}$
Carrier Depth	С	$\frac{2.36 \pm 0.10}{(0.093 - 0.004)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 - 0.002)}$
Reel Outside Diameter	D	<u>330</u> (12.992)
Reel Inner Diameter	D ₁	<u>50.0</u> (1.969) MIN.
Feed Hole Diameter	D ₂	$\frac{13.0 \pm 0.20}{(0.512 - 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 - 0.004))}$
Punch Hole Position	F	$\frac{7.50 \pm 0.10}{(0.295 - 0.004)}$
Punch Hole Pitch	Р	$\frac{4.00 \pm 0.10}{(0.157 - 0.004)}$
Sprocket Hole Pitch	P ₀	$\frac{4.00 \pm 0.10}{(0.157 - 0.004)}$
Embossment Center	P ₁	$\frac{2.00 \pm 0.10}{(0.079 - 0.004)}$
Overall Tape Thickness	Т	$\frac{0.30 \pm 0.10}{(0.012 - 0.004)}$
Tape Width	W	$\frac{16.00 \pm 0.20}{(0.630 - 0.008)}$
Reel Width	W ₁	$\frac{22.4}{(0.882)}$ MAX.
Quantity per Reel		3,000

REV. 01/18